

Small and high accuracy Temperature Sensor IC Series



Detect Temperature Changeable Thermostat Output Temperature Sensor ICs

BDF□□□0G Series

No.09047EAT04

●Description

Low quiescent current (16μA), high accuracy thermostat (temperature switch) ICs. Built in temperature sensor, reference voltage regulator, D/A converter, and comparator. Detecting temperature by itself, OS terminal state is changed at logically. Open Drain Output (Active L) is available in BDF□□□0G series.

●Features

- 1) Detection Temperature Range -10~+130°C by 8 products.
- 2) ±2.5°C Step Selectable Detection Temperature with C1 and C2.
- 3) Hysteresis Temperature (typically 10°C)
- 4) High Accuracy Analog Output (typically ±3.5°C@Ta=30°C)
- 5) Analog Output Temperature Sensitivity (typically -10.8mV/°C)
- 6) Low Supply Current (typically 16μA)
- 7) Small Package (typically 2.90mm×2.80mm×1.25mm)
- 8) ESD Rating 8kV (HBM)
- 9) Excellent Ripple Rejection Characteristic

●Applications

Thermal Protection for Electrical Equipment (NoteBook PC, Cell phone, FPD-TV, etc.) FAN Control for Thermal Management

●Products Line up

BDF

□□□

Detection Temperature
(Center Temperature)

120:120°C	040: 40°C
110:110°C	030: 30°C
100:100°C	020: 20°C
090: 90°C	010: 10°C
080: 80°C	000: 0°C
070: 70°C	910:-10°C
060: 60°C	920:-20°C
050: 50°C	

0

Output Format
(OpenDrain, Active Low)

G

Package
(SSOP6)

Temperature / Output Format Table

C1, C2 status description (L : Low, O : Open, H : High)

Product Name	Detection Temperature (°C)										OS Output Format		Marking
	C1	L	L	L	H	H	H	O	O	O			
	C2	L	H	O	L	H	O	L	H	O			
BDF1200G	110.0	112.5	115.0	117.5	120.0	122.5	125.0	127.5	130.0	Open Drain	Active Low	F0	
BDF1000G	90.0	92.5	95.0	97.5	100.0	102.5	105.0	107.5	110.0			F4	
BDF0800G	70.0	72.5	75.0	77.5	80.0	82.5	85.0	87.5	90.0			FA	
BDF0600G	50.0	52.5	55.0	57.5	60.0	62.5	65.0	67.5	70.0			FE	
BDF0400G	30.0	32.5	35.0	37.5	40.0	42.5	45.0	47.5	50.0			FJ	
BDF0200G	10.0	12.5	15.0	17.5	20.0	22.5	25.0	27.5	30.0			FN	
BDF0000G	-10.0	-7.5	-5.0	-2.5	0.0	2.5	5.0	7.5	10.0			FS	
BDF9200G	-30.0	-27.5	-25.0	-22.5	-20.0	-17.5	-15.0	-12.5	-10.0			FW	

●Absolute Maximum Ratings (Ta = 25°C)

Parameters	Symbol	Limit	Unit
Power Supply Voltage	VDD	-0.3 to 7.0 ^{*1}	V
Input Voltage (C1, C2)	VIN	-0.3 to VDD+0.3	V
Input Current (C1, C2)	IIN	-1.0, +0.1	mA
OS terminal Voltage	VOS	-0.3 to 7.0	V
OS terminal Current	IOS	5.0	mA
Power dissipation	Pd	540 ^{*2}	mW
Storage Temperature Range	Tstg	-55 to 150	°C

*1. Not to exceed Pd

*2. Reduced by 5.40mW for each increase in Ta of 1°C over 25°C(mounted on 70mm×70mm×1.6mm Glass-epoxy PCB)

●Recommended Operating Condition

Parameters	Symbol	Min.	Typ.	Max.	Unit
Power Supply Voltage	VDD	2.9	3.0	5.5	V
Operating Temperature Range	Topr	-30	-	130	°C

●Temperature Accuracy (unless otherwise specified, VDD = 3.0V)

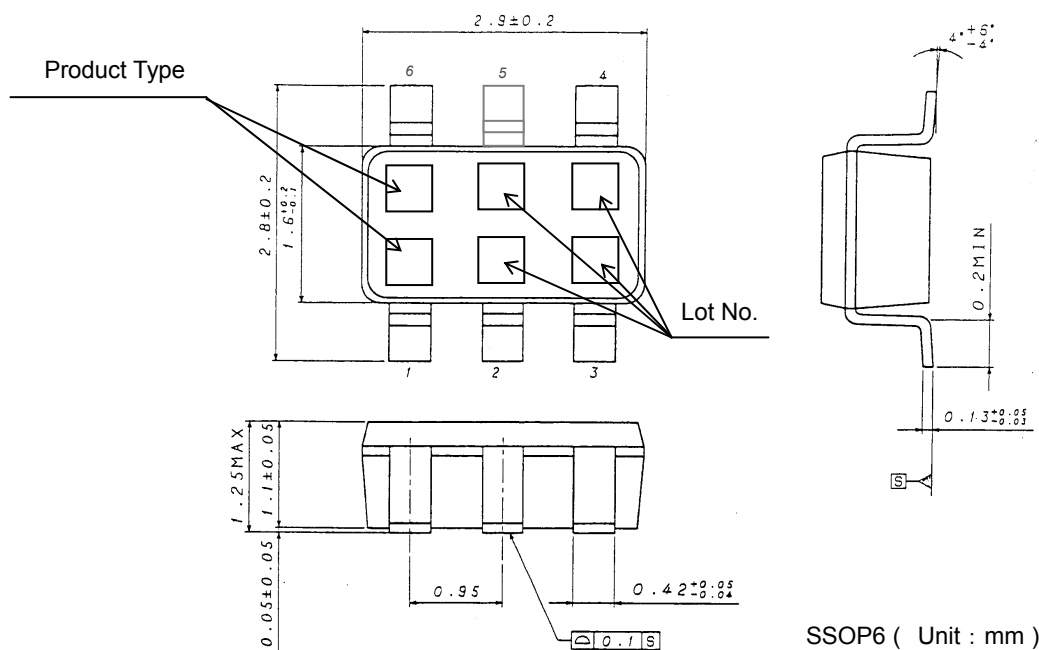
Parameter		Symbol	Limit			Unit	Conditions
			Min.	Typ.	Max.		
Thermostat (Temperature Switch)							
	Detection Temperature Accuracy	Tacc	-	0	±4.0 ±5.0	°C	Ta = -30°C~115°C Ta = ~130°C
	Detection Temperature Hysteresis	Thys	7.5	10.0	12.5	°C	
Analog Output							
	VTemp Temperature Accuracy	TTemp	-	-	±3.5	°C	Ta = 30°C

●Electrical Characteristics (unless otherwise specified, VDD = 3.0V, Ta = 25°C)

Parameter	Symbol	Limit			Unit	Conditions
		Min.	Typ.	Max.		
Supply Current	IDD	-	16.0	20.0	μA	C1, C2 = 3.0V
Analog Output						
VTemp Output Voltage	VTemp	1.716	1.753	1.790	V	Ta = 30°C
VTemp Temperature Sensitivity	VSE	-10.28	-10.68	-11.08	mV/°C	Ta = -30 to 100°C
VTemp Load Regulation	ΔVTempRL	-	-	1	mV	difference of IOUT : 0μA / 2μA
OS Output Open Drain						
OS Leakage Current	IL	-	-	1.0	μA	OS : 5.0V
OS Output Voltage	VOL	-	-	0.4	V	IINOS = 1.2mA
C1, C2						
Input L Voltage	VIL	GND	-	0.6	V	
Input H Voltage	VIH	2.4	-	VDD	V	

*Radiation hardness is not designed.

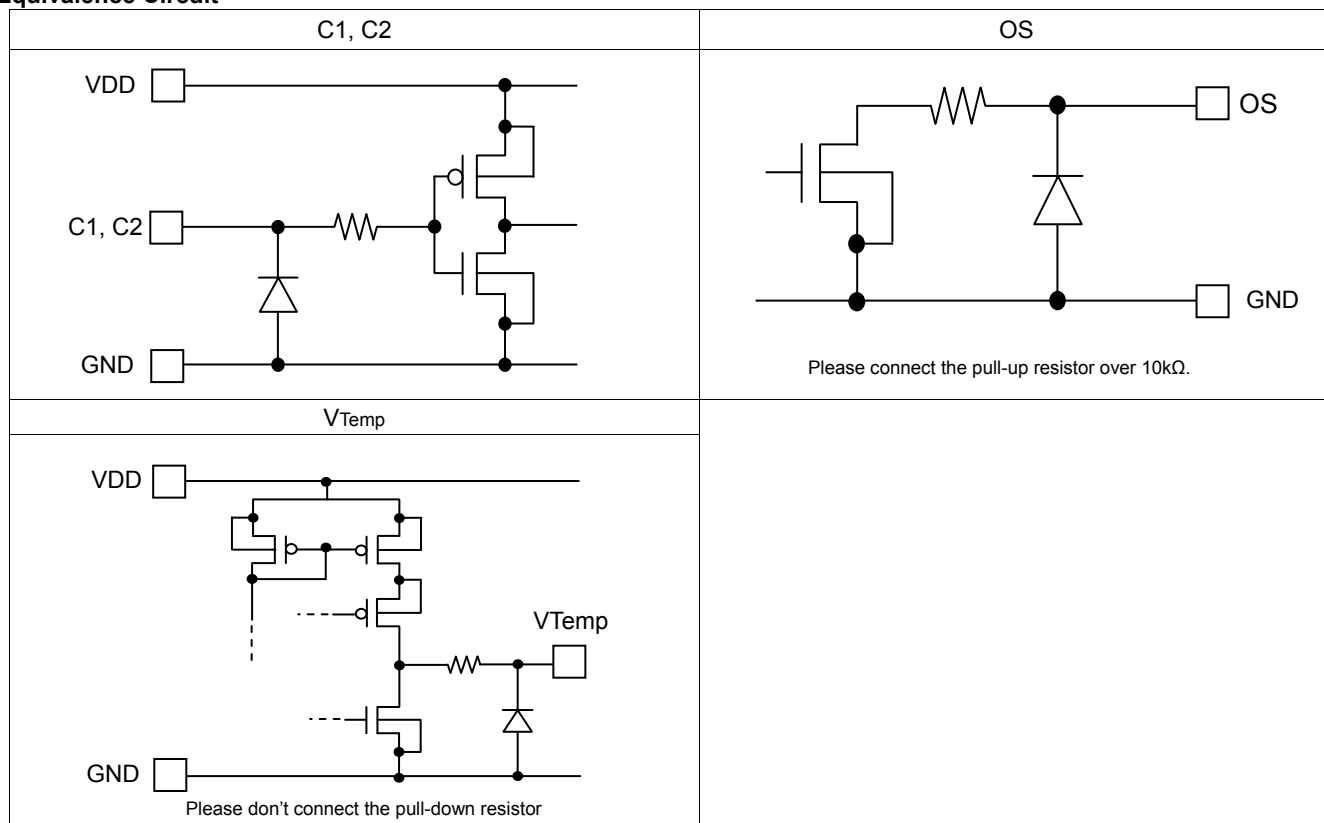
●Package Outline



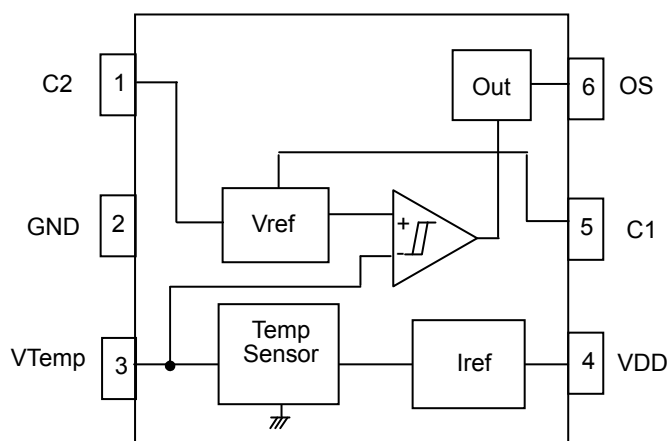
●Pin Description

Pin No.	Pin Name	Function	Comment
1	C2	Detection temperature setting	Refer to 2/7 page for the temperature set. (Temperature / Output Format Table)
2	GND	Ground	
3	VTemp	Output voltage in inverse proportion to the temperature (Typ. -10.68mV/°C)	Set the Open state or Connect high impedance input node.
4	VDD	Power Supply	
5	C1	Detection temperature setting	Refer to 2/7 page for the temperature set. (Temperature / Output Format Table)
6	OS	Digital thermostat output	Open Drain type Use the pull-up resistor over 10kΩ.

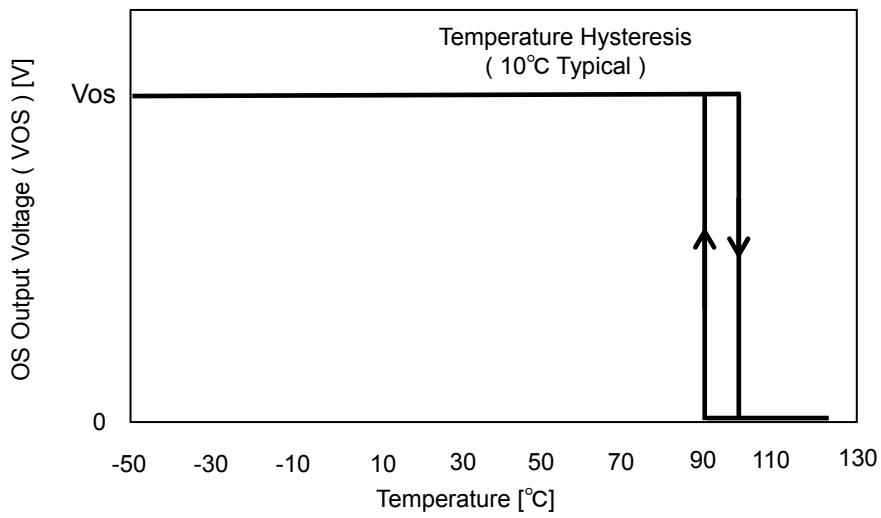
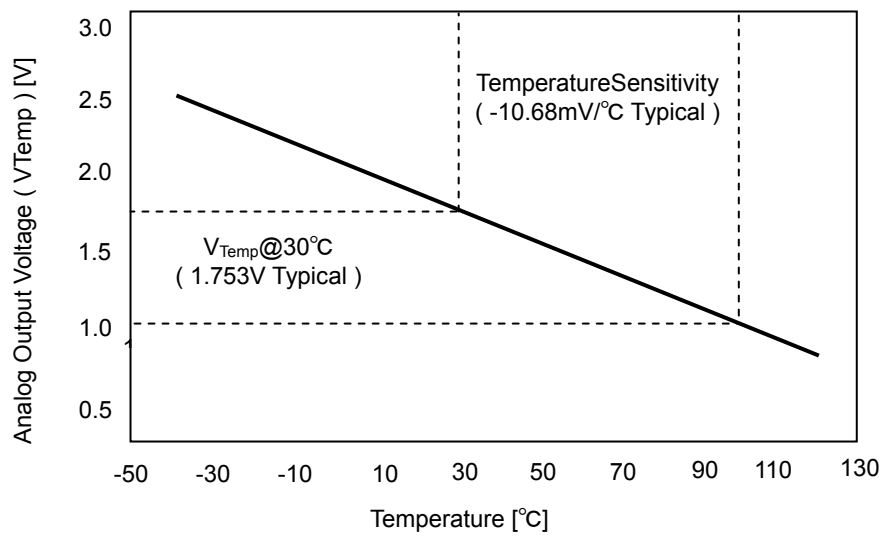
●Equivalence Circuit



●Block Diagram



●Functional Diagram (ex. Detection Temperature 100°C)



●Reference Data

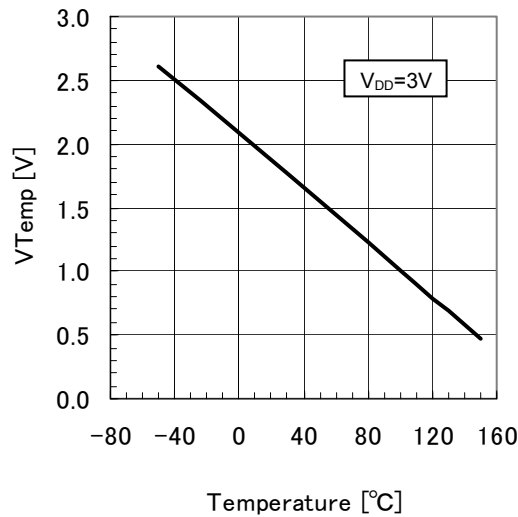


Fig1. VTemp Voltage vs. Temperature (Temperature Sensitivity)

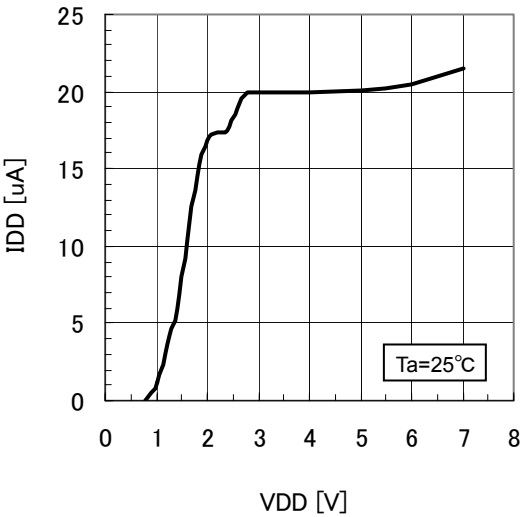


Fig2. Supply Current vs. Supply Voltage

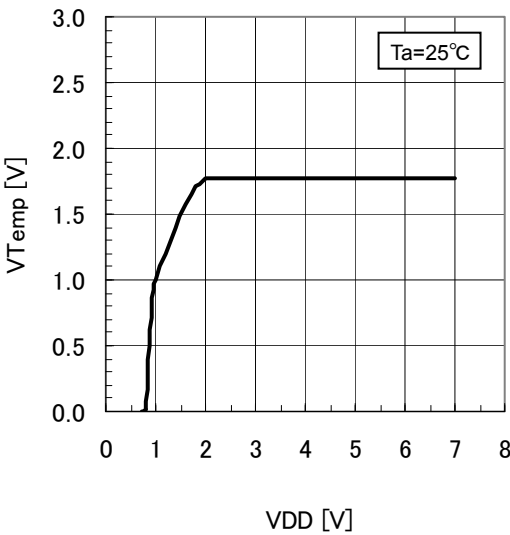


Fig3. VTemp Voltage vs. Supply Voltage

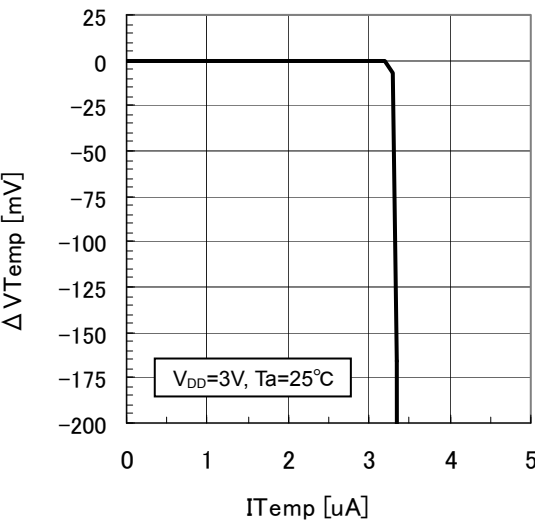


Fig4. VTemp Voltage vs. Output Current

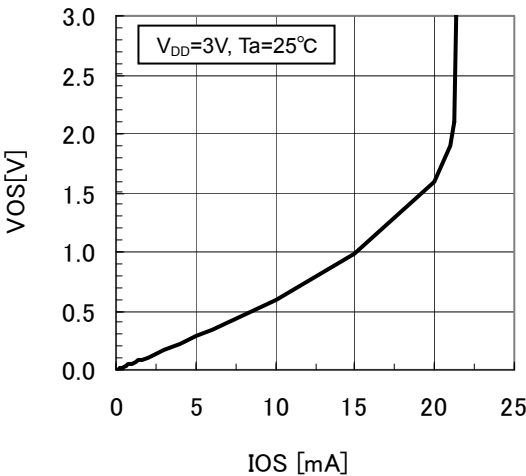


Fig5. OS Output Voltage vs. Load Current

●Notes for use

1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.

2) GND voltage

Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state.

3) Pin short and mistake fitting

When mounting the IC on the PCB, pay attention to the orientation of the IC. If there is a placement mistake, the IC may be burned up.

4) Operation in strong electric field

Be noted that using ICs in the strong electric field can malfunction them.

5) Mutual impedance

Use short and wide wiring tracks for the power supply and ground to keep the mutual impedance as small as possible.

Use a capacitor to keep ripple to a minimum.

●Ordering part number

B	D	F
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Part No.

0	0	0	0
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Part No.

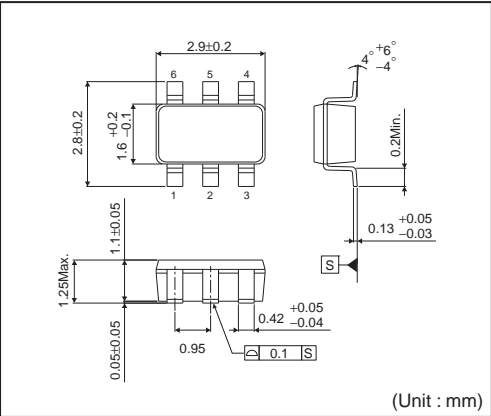
0000	0100	0200
0300	0400	0500
0600	0700	0800
0900	1000	1100
1200	9100	9200

G	-	T	R
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Package
G: SSOP6

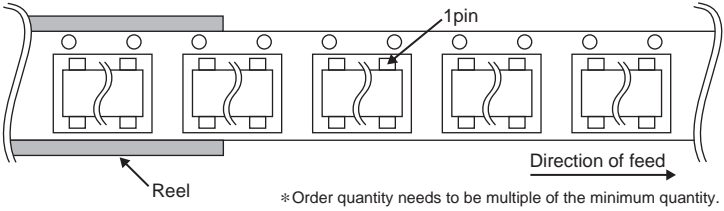
Packaging and forming specification
TR: Embossed tape and reel
(SSOP6)

SSOP6



<Tape and Reel information>

Tape	Embossed carrier tape
Quantity	3000pcs
Direction of feed	TR (The direction is the 1pin of product is at the upper right when you hold reel on the left hand and you pull out the tape on the right hand)



Notes

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